



Application No. _____

LPI-IP Extended Master Installation Certificate Application

Date of Application: _____ Date of Installation: _____

On-Site Inspection Required by Applicant: Yes No

14048 W. Petronella Dr.
Suite 104
Libertyville, IL 60048
(224) 433-6680

Standard: LPI-175 NFPA 780 UL96A

UFC 3-575-01 AFI 32-1065 PAM 385-64 NAVSEA OPS

Scope: Structural w/ Surge Structural Only

Section I Applicant:

Installation Contractor Name : _____

LPI Master Installer Name / Number: _____

Address: _____

City: _____ State: _____ Zip: _____

Office Contact Name: _____

Phone: _____ Email: _____

Inspection Contact Name: _____

Phone: _____ Email: _____

Section II Building:

Building Name: _____

Address: _____

City: _____ State: _____ Zip: _____

Applicant Job Number: _____

Contact Name: _____

Phone: _____ Email: _____

Residential Commercial Other _____

Section III Site Witnesses:

Grounding Witness*: _____

Company: _____ Title: _____

Address: _____

City: _____ State: _____ Zip: _____

Phone: _____ Email: _____

Signature†: _____ Date: _____

Check if contact information is the same as above (second signature still required)

Lightning Protection Witness*: _____

Company: _____ Title: _____

Address: _____

City: _____ State: _____ Zip: _____

Phone: _____ Email: _____

Signature†: _____ Date: _____

*Note: Witness must be the General Contractor, Electrical Contractor, or Owner's Representative

†Note: Witness' signature verifies that: i) the installing contractor has explained and described the grounding or lightning protection installation to the witness, and ii) the work was completed as described.

APPLICATION ONLY - NOT A CERTIFICATION



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Section IV System Design:

Is structure intended or used for the manufacturing, storage or handling of explosives or flammable liquids? Yes No

Perimeter of Structure: _____ Maximum Height of Structure: _____

Exposed Concealed (If concealed, pictures must be attached)

Is structural steel used in lieu of Down Conductors? Yes No N/A

Type & Material of Electrodes: _____ (Pictures must be attached)

No. of Electrodes: _____ Depth of Electrodes: _____

Down Conductor Material: Copper Aluminum Other _____

Roof Top System Material: Copper Aluminum Other _____

Section V Equipotential Bonding:

Is the incoming water service bonded to the system? Yes No N/A

With main size conductor, equivalent or greater? Yes No N/A

Location of Water Bond: _____

Is the incoming electric service bonded to the system? Yes No N/A

Method: Direct Bonding Water Pipe Other _____

Is the incoming gas service bonded to the system? Yes No N/A

Method: Direct Bonding Water Pipe Other _____

Are all incoming data services bonded to the system? Yes No N/A

Method: Direct Bonding Water Pipe Other _____

Are all grounded metal bodies bonded per standard(s)? Yes No N/A

Is the testing plan approved by the AHJ? Yes No N/A

Section VI Installer Statement:

INSTALLER STATEMENT

I certify that the materials utilized in this installation comply with the material considerations and minimum requirements detailed in the current edition of the standard specified in this application, and all such materials are installed in such a way to comply with installation requirements detailed in the current edition of the standard specified in this application. I also certify that any and all witness signatures submitted on this application are authentic and all information on this application is correct to best of my knowledge at the time of submission. I understand that if any deviations are found in any part of the system design or installation, those deviations must be corrected in the time allotted by the LPI-IP or the owner will be contacted

I have included the **following required items** as part of the application:

System Drawings Test Plan

Dated Pictures of Lightning Protection System Dated Pictures of Grounding System

Photo Release Letter (Pictures Not Allowed) Other _____

Signature: _____ Date: _____

